MRF137

The RF MOSFET Line
30W, to 400MHz, 28V

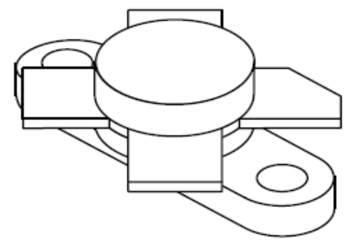
M/A-COM Products
Released - Rev. 05202009

Designed for wideband large signal output and drive stages up to 400 MHz range.

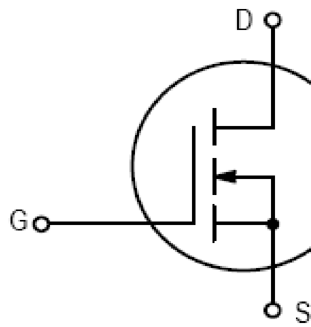
N–Channel enhancement mode

- Guaranteed 28 V, 150 MHz performance
  - Output power = 30 W
  - Minimum gain = 13 dB
  - Efficiency — 60% (Typical)
- Small– and large–signal characterization
- Typical performance at 400 MHz, 28 Vdc, 30 W output = 7.7 dB gain
- 100% tested for load mismatch at all phase angles with 30:1 VSWR
- Low noise figure — 1.5 dB (typ.) at 1.0 A, 150 MHz
- Excellent thermal stability, ideally suited for Class A operation
- Facilitates manual gain control, ALC and modulation techniques

Product Image



CASE 211–07, STYLE 2



MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain–Source Voltage	V_{DSS}	65	Vdc
Drain–Gate Voltage (R_{GS} = 1.0 MΩ)	V_{DGR}	65	Vdc
Gate–Source Voltage	V_{GS}	±40	Vdc
Drain Current — Continuous	I_D	2.5	Adc
Total Device Dissipation @ T_C = 25°C Derate above 25°C	P_D	55 0.314	Watts W/°C
Storage Temperature Range	T_{stg}	–65 to +150	°C
Operating Junction Temperature	T_J	200	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	3.2	°C/W

NOTE – CAUTION – MOS devices are susceptible to damage from electrostatic charge. Reasonable precautions in handling and packaging MOS devices should be observed.

- **North America** Tel: 800.366.2266 / Fax: 978.366.2266
- **Europe** Tel: 44.1908.574.200 / Fax: 44.1908.574.300
- **Asia/Pacific** Tel: 81.44.844.8296 / Fax: 81.44.844.8298

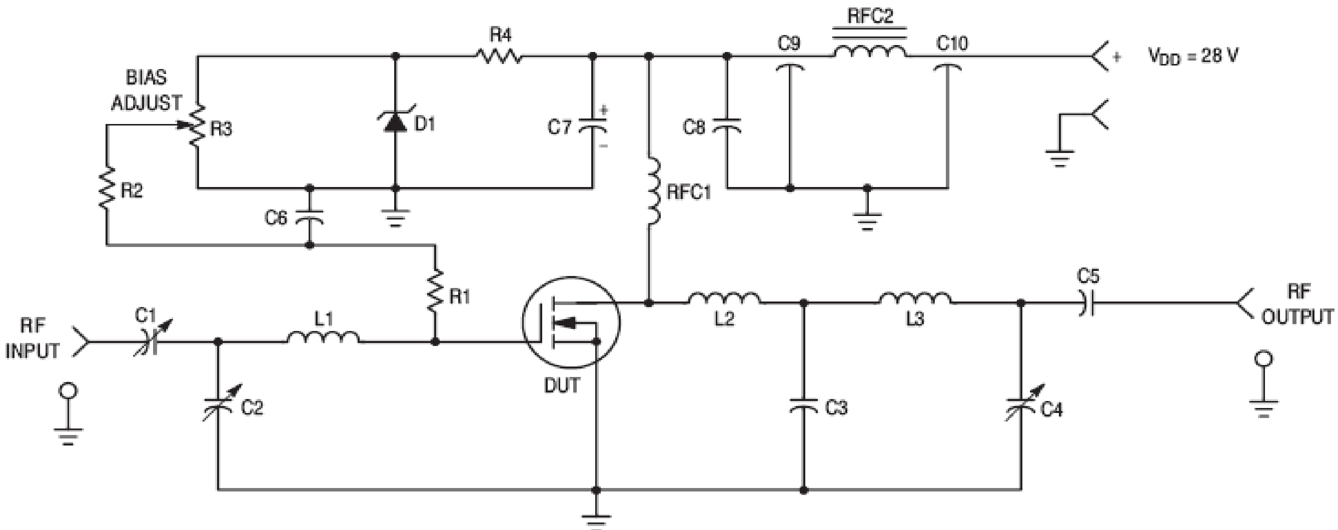
Visit www.macomtech.com for additional data sheets and product information.

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Drain–Source Breakdown Voltage (V_{GS} = 0, I_D = 10 mA)	$V_{(BR)DSS}$	65	—	—	Vdc
Zero Gate Voltage Drain Current (V_{DS} = 28 V, V_{GS} = 0)	I_{DSS}	—	—	4.0	mAdc
Gate–Source Leakage Current (V_{GS} = 20 V, V_{DS} = 0)	I_{GSS}	—	—	1.0	µAdc
ON CHARACTERISTICS					
Gate Threshold Voltage (V_{DS} = 10 V, I_D = 25 mA)	$V_{GS(th)}$	1.0	3.0	6.0	Vdc
Forward Transconductance (V_{DS} = 10 V, I_D = 500 mA)	g_{fs}	500	750	—	mmhos
DYNAMIC CHARACTERISTICS					
Input Capacitance (V_{DS} = 28 V, V_{GS} = 0, f = 1.0 MHz)	C_{iss}	—	48	—	pF
Output Capacitance (V_{DS} = 28 V, V_{GS} = 0, f = 1.0 MHz)	C_{oss}	—	54	—	pF
Reverse Transfer Capacitance (V_{DS} = 28 V, V_{GS} = 0, f = 1.0 MHz)	C_{rss}	—	11	—	pF
FUNCTIONAL CHARACTERISTICS					
Noise Figure (V_{DS} = 28 Vdc, I_D = 1.0 A, f = 150 MHz)	NF	—	1.5	—	dB
Common Source Power Gain (V_{DD} = 28 Vdc, P_{out} = 30 W, I_{DQ} = 25 mA) f = 150 MHz (Figure 1)	G_{ps}	13	16	—	dB
f = 400 MHz (Figure 14)		—	7.7	—	
Drain Efficiency (Figure 1) (V_{DD} = 28 Vdc, P_{out} = 30 W, f = 150 MHz, I_{DQ} = 25 mA)	η	50	60	—	%
Electrical Ruggedness (Figure 1) (V_{DD} = 28 Vdc, P_{out} = 30 W, f = 150 MHz, I_{DQ} = 25 mA, VSWR 30:1 at All Phase Angles)	ψ	No Degradation in Output Power			

- **North America** Tel: 800.366.2266 / Fax: 978.366.2266
- **Europe** Tel: 44.1908.574.200 / Fax: 44.1908.574.300
- **Asia/Pacific** Tel: 81.44.844.8296 / Fax: 81.44.844.8298

Visit www.macomtech.com for additional data sheets and product information.



C1 — Arco 403, 3.0–35 pF, or equivalent
C2 — Arco 406, 15–115 pF, or equivalent
C3 — 56 pF Mini–Unelco, or equivalent
C4 — Arco 404, 8.0–60 pF, or equivalent
C5 — 680 pF, 100 Mils Chip
C6 — 0.01 µF, 100 V, Disc Ceramic
C7 — 100 µF, 40 V
C8 — 0.1 µF, 50 V, Disc Ceramic
C9, C10 — 680 pF Feedthru
D1 — 1N5925A Motorola Zener

L1 — 2 Turns, 0.29″ ID, #18 AWG Enamel, Closewound
L2 — 1–1/4 Turns, 0.2″ ID, #18 AWG Enamel, Closewound
L3 — 2 Turns, 0.2″ ID, #18 AWG Enamel, Closewound
RFC1 — 20 Turns, 0.30″ ID, #20 AWG Enamel, Closewound
RFC2 — Ferroxcube VK–200 — 19/4B
R1 — 10 kΩ, 1/2 W Thin Film
R2 — 10 kΩ, 1/4 W
R3 — 10 Turns, 10 kΩ
R4 — 1.8 kΩ, 1/2 W
Board — G10, 62 Mils

Figure 1. 150 MHz Test Circuit

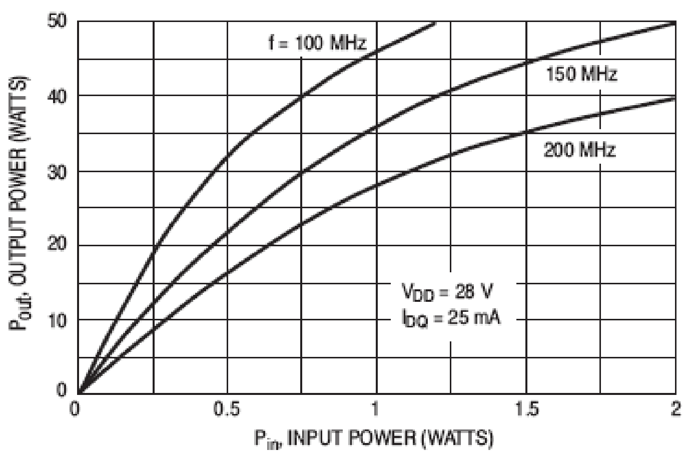


Figure 2. Output Power versus Input Power

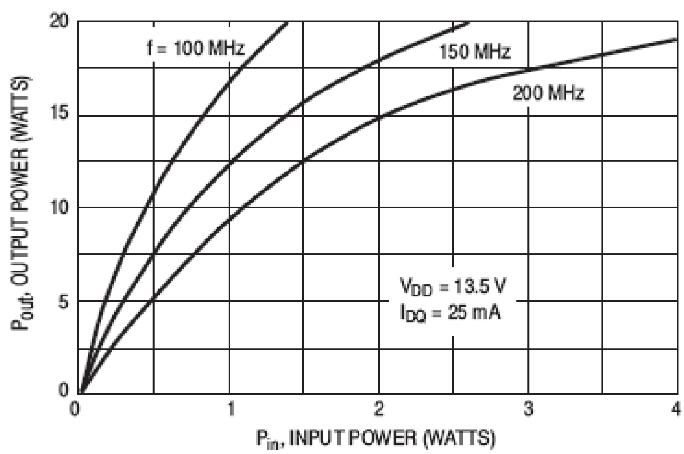


Figure 3. Output Power versus Input Power

- **North America** Tel: 800.366.2266 / Fax: 978.366.2266
- **Europe** Tel: 44.1908.574.200 / Fax: 44.1908.574.300
- **Asia/Pacific** Tel: 81.44.844.8296 / Fax: 81.44.844.8298

Visit www.macomtech.com for additional data sheets and product information.

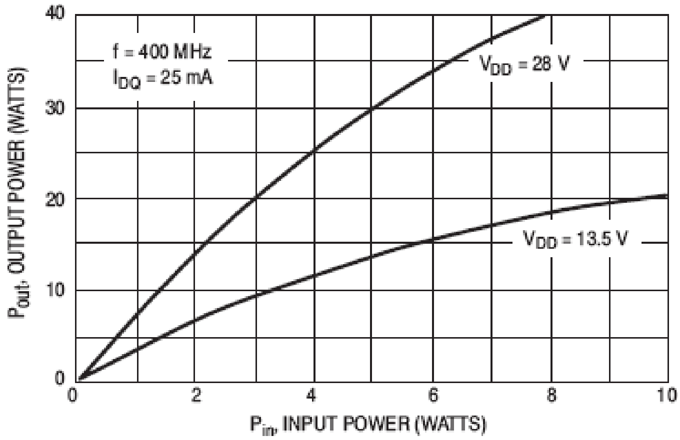


Figure 4. Output Power versus Input Power

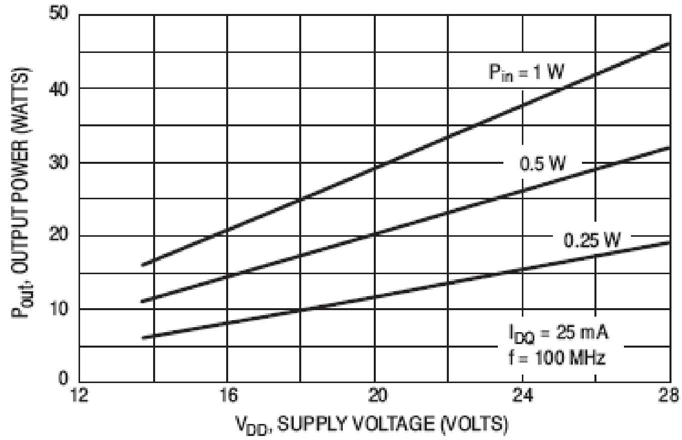


Figure 5. Output Power versus Supply Voltage

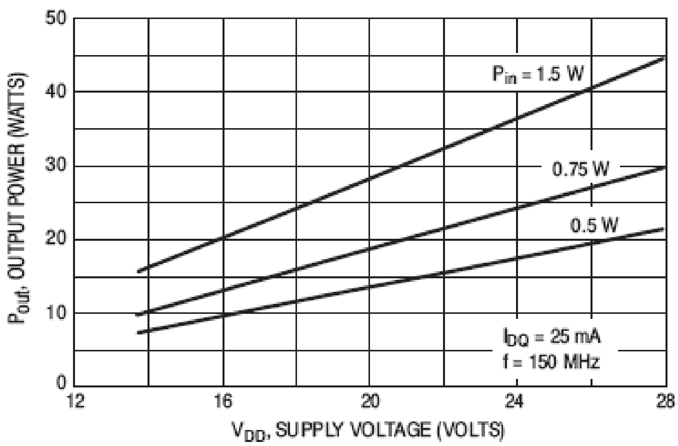


Figure 6. Output Power versus Supply Voltage

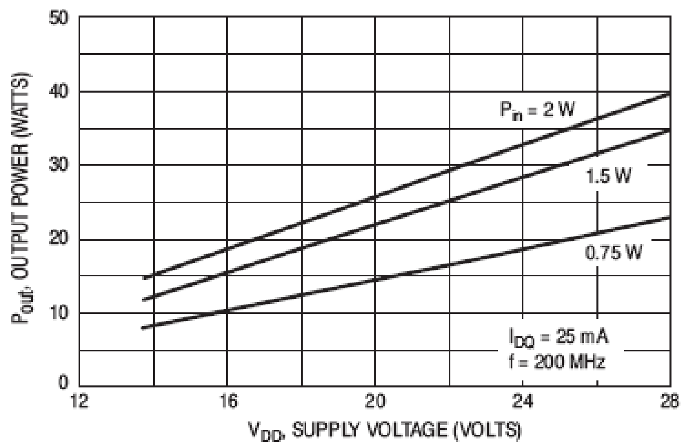


Figure 7. Output Power versus Supply Voltage

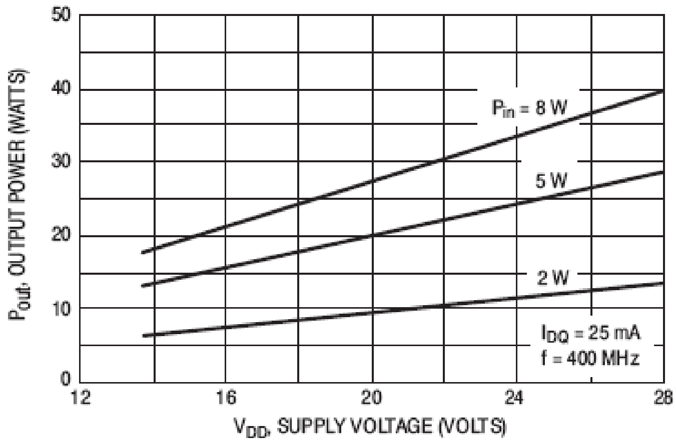


Figure 8. Output Power versus Supply Voltage

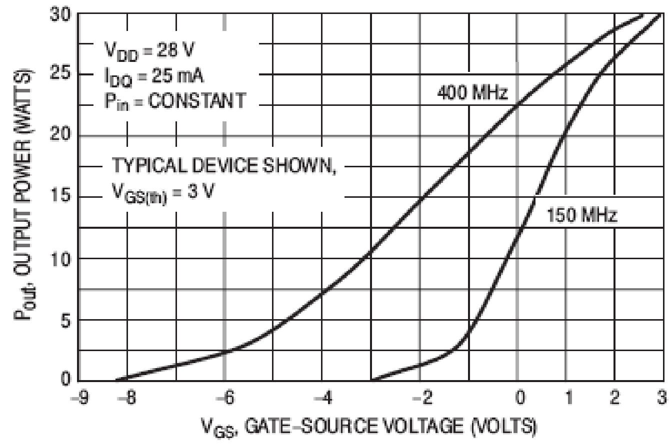


Figure 9. Output Power versus Gate Voltage

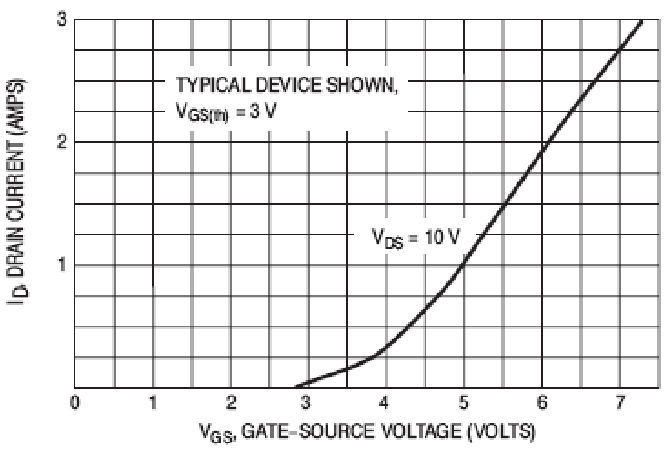


Figure 10. Drain Current versus Gate Voltage (Transfer Characteristics)

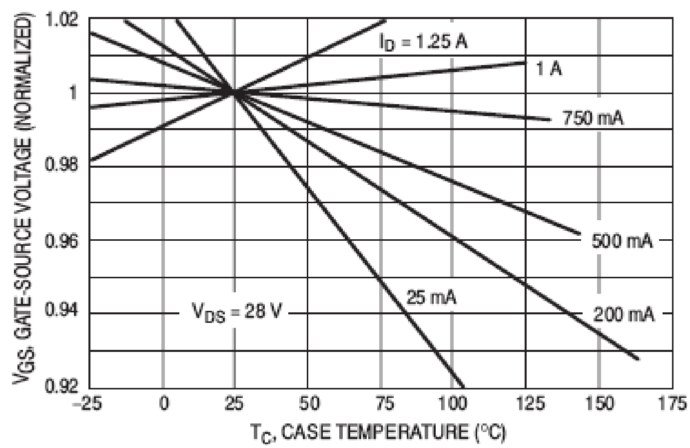


Figure 11. Gate Source Voltage versus Case Temperature

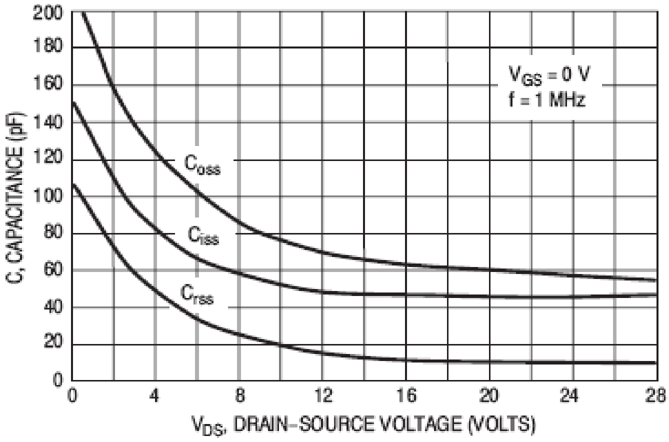


Figure 12. Capacitance versus Drain–Source Voltage

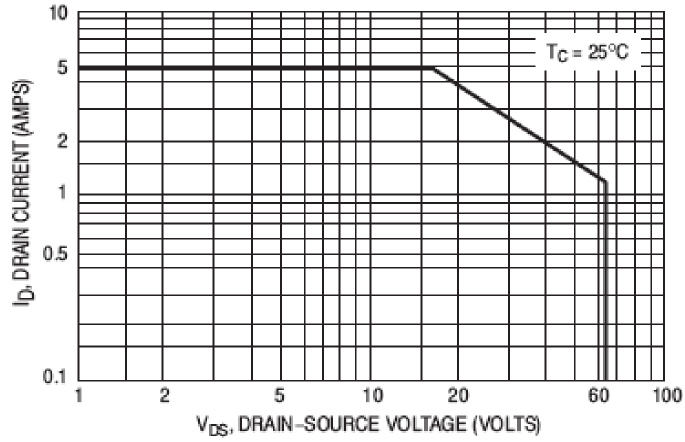
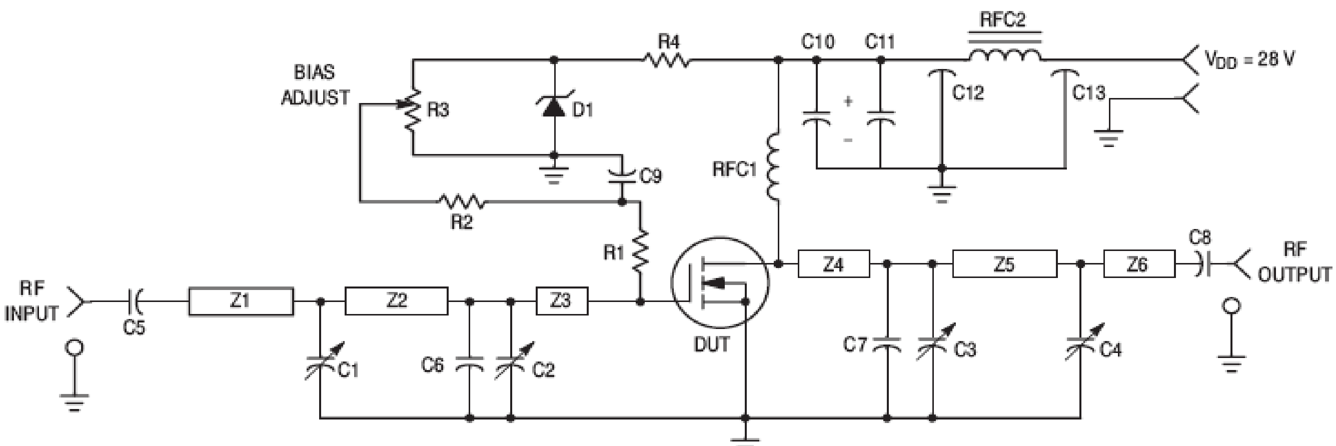


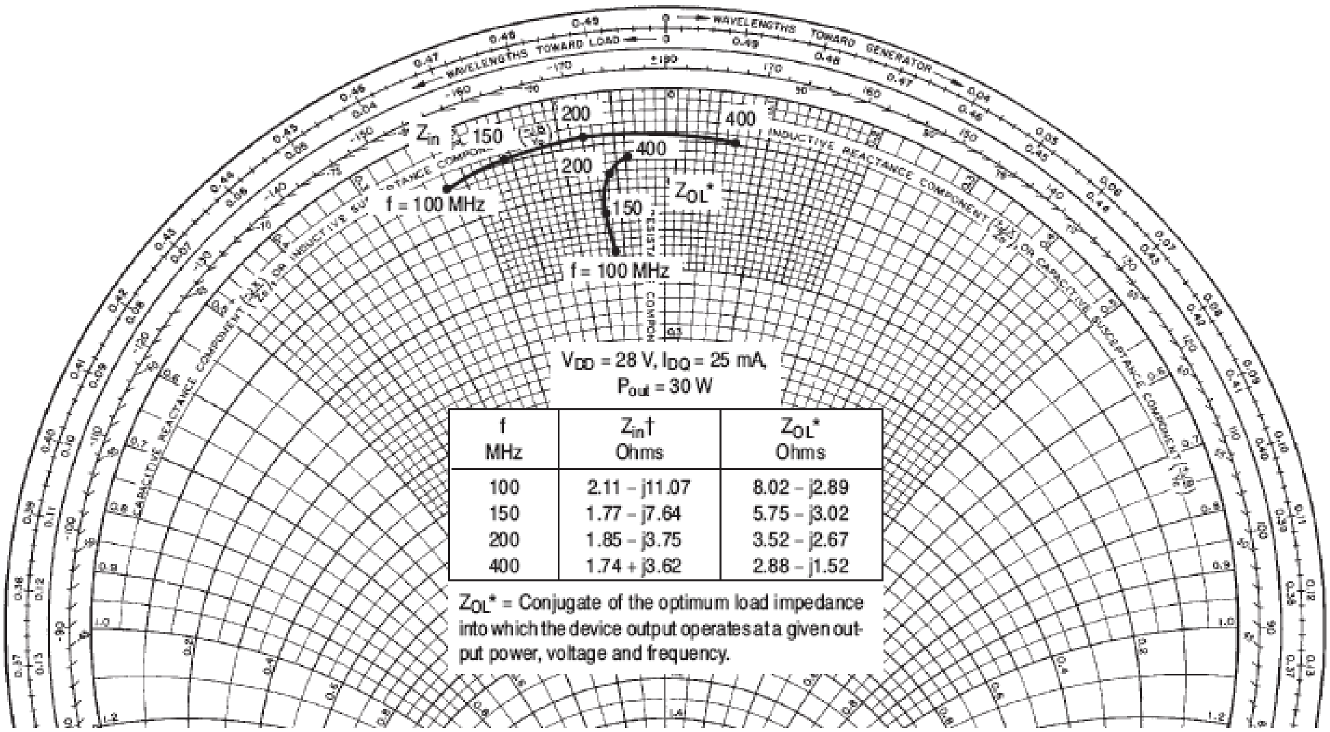
Figure 13. DC Safe Operating Area



C1, C2, C3, C4 — 0–20 pF Johanson, or equivalent
C5, C8 — 270 pF, 100 Mil Chip
C6, C7 — 24 pF Mini–Unelco, or equivalent
C9 — 0.01 µF, 100 V, Disc Ceramic
C10 — 100 µF, 40 V
C11 — 0.1 µF, 50 V, Disc Ceramic
C12, C13 — 680 pF Feedthru
D1 — 1N5925A Motorola Zener
R1, R2 — 10 kΩ, 1/4 W
R3 — 10 Turns, 10 kΩ
R4 — 1.8 kΩ, 1/2 W
Z1 — 2.9″ x 0.166″ Microstrip
Z2, Z4 — 0.35″ x 0.166″ Microstrip
Z3 — 0.40″ x 0.166″ Microstrip
Z5 — 1.05″ x 0.166″ Microstrip
Z6 — 1.9″ x 0.166″ Microstrip
RFC1 — 6 Turns, 0.300″ ID, #20 AWG Enamel, Closewound
RFC2 — Ferroxcube VK–200 — 19/4B
Board — Glass Teflon, 62 Mils

Figure 14. 400 MHz Test Circuit

• **North America** Tel: 800.366.2266 / Fax: 978.366.2266
• **Europe** Tel: 44.1908.574.200 / Fax: 44.1908.574.300
• **Asia/Pacific** Tel: 81.44.844.8296 / Fax: 81.44.844.8298
Visit www.macomtech.com for additional data sheets and product information.



f MHz	Z_{in}† Ohms	Z_{OL}* Ohms
100	2.11 – j11.07	8.02 – j2.89
150	1.77 – j7.64	5.75 – j3.02
200	1.85 – j3.75	3.52 – j2.67
400	1.74 + j3.62	2.88 – j1.52

Figure 15. Large–Signal Series Equivalent Input and Output Impedance, Z_{in}, Z_{OL}*

- **North America** Tel: 800.366.2266 / Fax: 978.366.2266
- **Europe** Tel: 44.1908.574.200 / Fax: 44.1908.574.300
- **Asia/Pacific** Tel: 81.44.844.8296 / Fax: 81.44.844.8298

Visit www.macomtech.com for additional data sheets and product information.

f (MHz)	S_{11}		S_{21}		S_{12}		S_{22}	
	$\|S_{11}\|$	∠ϕ	$\|S_{21}\|$	∠ϕ	$\|S_{12}\|$	∠ϕ	$\|S_{22}\|$	∠ϕ
2.0	0.977	–32	59.48	163	0.011	67	0.661	–36
5.0	0.919	–70	48.67	142	0.024	44	0.692	–78
10	0.852	–109	33.50	122	0.032	29	0.747	–117
20	0.817	–140	19.05	106	0.037	16	0.768	–146
30	0.814	–153	13.11	99	0.038	14	0.774	–157
40	0.811	–159	9.88	95	0.038	13	0.782	–162
50	0.812	–164	7.98	92	0.038	12	0.787	–165
60	0.813	–166	6.66	89	0.038	12	0.787	–168
70	0.815	–168	5.708	86	0.038	11	0.787	–169
80	0.816	–170	5.003	84	0.038	11	0.787	–170
90	0.817	–171	4.560	83	0.038	12	0.787	–171
100	0.817	–172	4.170	81	0.039	13	0.787	–172
110	0.818	–173	3.670	80	0.039	13	0.788	–172
120	0.820	–173	3.420	79	0.039	13	0.788	–173
130	0.821	–173	3.170	79	0.039	13	0.788	–173
140	0.822	–174	2.980	78	0.039	13	0.788	–173
150	0.823	–175	2.826	77	0.039	14	0.788	–173
160	0.824	–175	2.650	76	0.039	14	0.790	–174
170	0.825	–176	2.438	75	0.039	14	0.792	–174
180	0.827	–176	2.325	73	0.039	15	0.793	–174
190	0.829	–177	2.175	72	0.039	16	0.796	–174
200	0.831	–177	2.084	71	0.039	16	0.799	–174
225	0.836	–178	1.824	69	0.039	18	0.805	–174
250	0.846	–178	1.621	66	0.039	21	0.816	–174
275	0.853	–179	1.462	64	0.039	23	0.822	–174
300	0.853	–179	1.319	61	0.040	25	0.833	–174
325	0.856	–179	1.194	59	0.040	27	0.828	–174
350	0.857	+179	1.089	56	0.040	30	0.842	–174
375	0.861	+179	1.014	54	0.042	32	0.849	–174
400	0.865	+178	0.927	51	0.043	35	0.856	–174
425	0.875	+178	0.876	49	0.045	37	0.866	–174
450	0.881	+178	0.810	46	0.046	40	0.870	–174
475	0.886	+177	0.755	44	0.046	43	0.875	–174
500	0.887	+177	0.694	41	0.051	43	0.888	–174
525	0.888	+176	0.677	39	0.052	43	0.890	–174
550	0.896	+176	0.625	36	0.055	45	0.898	–174
575	0.907	+175	0.603	34	0.058	45	0.913	–174
600	0.910	+175	0.585	32	0.061	45	0.918	–174
625	0.910	+174	0.563	30	0.065	45	0.945	–174
650	0.920	+174	0.543	28	0.069	46	0.952	–174
675	0.938	+173	0.533	26	0.074	47	0.974	–174
700	0.943	+171	0.515	24	0.078	47	0.958	–176
725	0.934	+170	0.491	22	0.079	46	0.953	–177
750	0.940	+170	0.475	22	0.084	48	0.943	–177
775	0.953	+169	0.477	21	0.090	48	0.957	–177
800	0.959	+168	0.467	17	0.093	48	0.957	–179

Table 1. Common Source Scattering Parameters
50 Ω System
V_{DS} = 28 V, I_D = 0.75 A

- **North America** Tel: 800.366.2266 / Fax: 978.366.2266
- **Europe** Tel: 44.1908.574.200 / Fax: 44.1908.574.300
- **Asia/Pacific** Tel: 81.44.844.8296 / Fax: 81.44.844.8298

Visit www.macomtech.com for additional data sheets and product information.

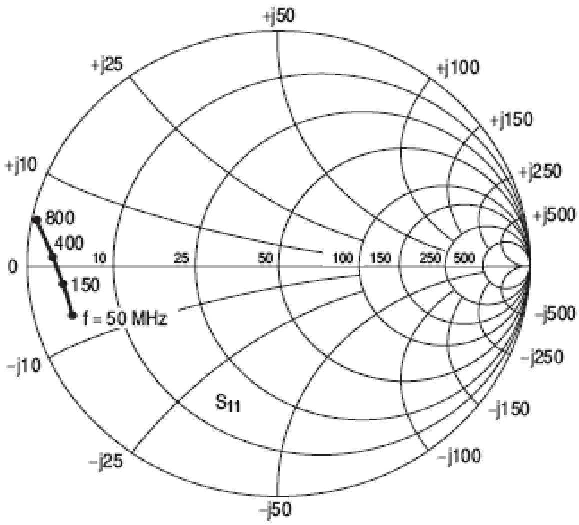


Figure 16. S_{11}, Input Reflection Coefficient versus Frequency
V_{DS} = 28 V I_D = 0.75 A

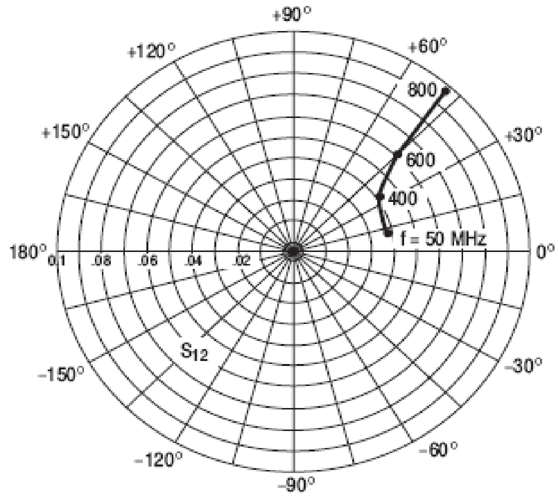


Figure 17. S_{12}, Reverse Transmission Coefficient versus Frequency
V_{DS} = 28 V I_D = 0.75 A

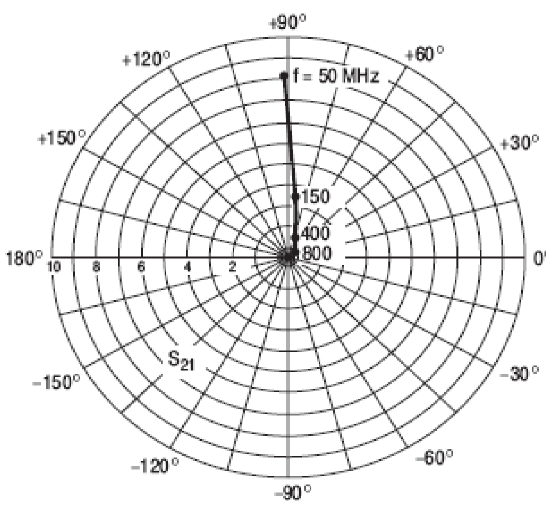


Figure 18. S_{21}, Forward Transmission Coefficient versus Frequency
V_{DS} = 28 V I_D = 0.75 A

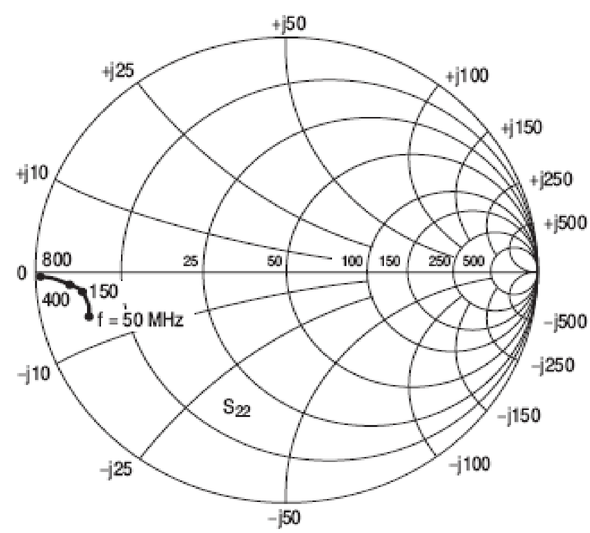


Figure 19. S_{22}, Output Reflection Coefficient versus Frequency
V_{DS} = 28 V I_D = 0.75 A

RF POWER MOSFET CONSIDERATIONS

DESIGN CONSIDERATIONS

The MRF137 is a RF power N–Channel enhancement-mode field–effect transistor (FET) designed especially for VHF power amplifier applications. M/A-COM RF MOS FETs feature a vertical structure with a planar design, thus avoiding the processing difficulties associated with V–groove vertical power FETs.

M/A-COM Application Note AN211A, FETs in Theory and-Practice, is suggested reading for those not familiar with the construction and characteristics of FETs.

The major advantages of RF power FETs include high gain, low noise, simple bias systems, relative immunity from thermal runaway, and the ability to withstand severely mismatched loads without suffering damage. Power output can be varied over a wide range with a low power dc control signal, thus facilitating manual gain control, ALC and modulation.

DC BIAS

The MRF137 is an enhancement mode FET and, therefore, does not conduct when drain voltage is applied. Drain current flows when a positive voltage is applied to the gate. See Figure 10 for a typical plot of drain current versus gate voltage. RF power FETs require forward bias for optimum performance.

The value of quiescent drain current (I_{DQ}) is not critical formany applications. The MRF137 was characterized at I_{DQ} = 25 mA, which is the suggested minimum value of I_{DQ}. For special applications such as linear amplification, I_{DQ} may have to be selected to optimize the critical parameters.

The gate is a dc open circuit and draws no current. Therefore, the gate bias circuit may generally be just a simple resistive divider network. Some special applications may require a more elaborate bias system.

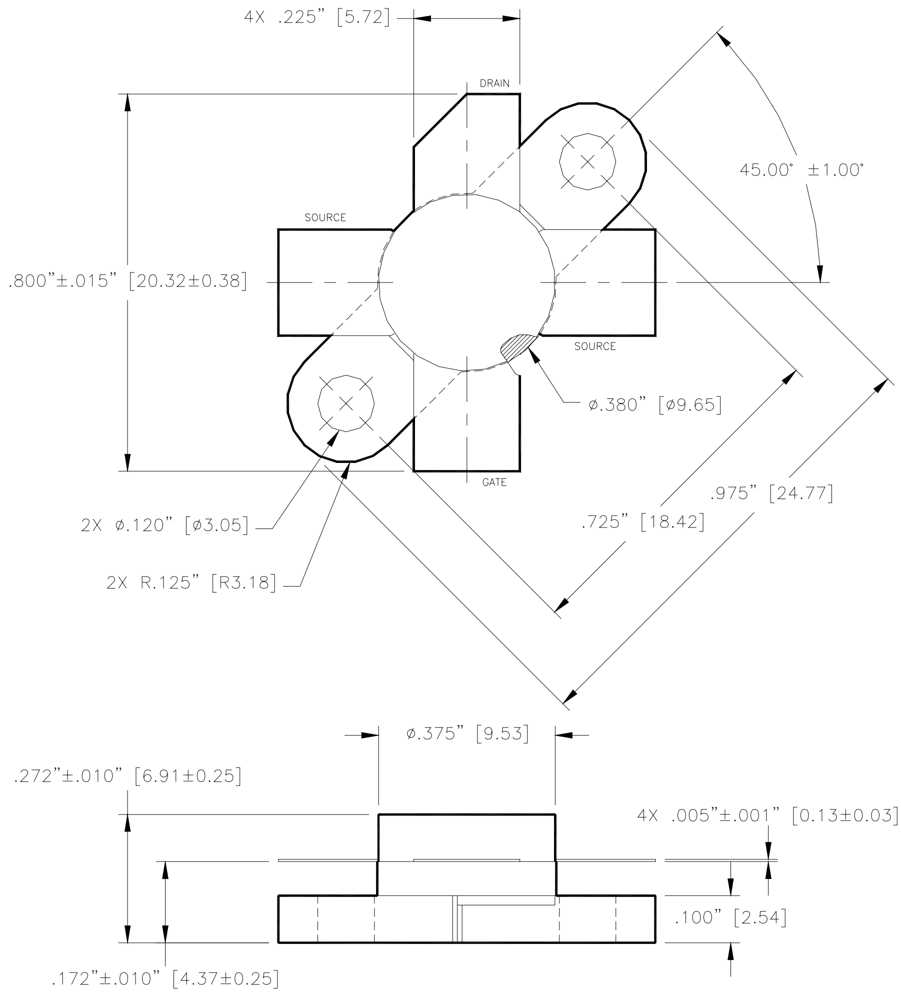
GAIN CONTROL

Power output of the MRF137 may be controlled from its rated value down to zero (negative gain) by varying the dc gate voltage. This feature facilitates the design of manual gain control, AGC/ALC and modulation systems. (See Figure 9.)

AMPLIFIER DESIGN

Impedance matching networks similar to those used with bipolar VHF transistors are suitable for MRF137. See M/A-COM Application Note AN721, Impedance Matching Networks Applied to RF Power Transistors. The higher input impedance of RF MOS FETs helps ease the task of broadband network design. Both small signal scattering parameters and large signal impedances are provided. While the s–parameters will not produce an exact design solution for high power operation, they do yield a good first approximation. This is an additional advantage of RF MOS power FETs.

RF power FETs are triode devices and, therefore, not unilateral. This, coupled with the very high gain of the MRF137, yields a device capable of self oscillation. Stability may be achieved by techniques such as drain loading, input shunt resistive loading, or output to input feedback. Two port parameter stability analysis with the MRF137 s–parameters provides a useful tool for selection of loading or feedback circuitry to assure stable operation. See M/A-COM Application Note AN215A for a discussion of two port network theory and stability.



Unless otherwise noted, tolerances are inches ±.005" [millimeters ±0.13mm]